



P-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
- 40	$0.015 \text{ at V}_{GS} = -10 \text{ V}$	- 16.1	33 nC			
- 40	0.022 at V _{GS} = - 4.5 V	- 13.3	33 110			

FEATURES

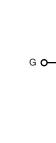
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- 100 % R_g Tested
- 100 % UIS Tested
 - Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN **FREE**

APPLICATIONS

- Load Switch
- POL



P-Channel MOSFET

		SO-8		
S	1		8	D
S	2		7	D
S	3		6	D
G	4		5	D
	ļ	Top View	J	

Ordering Information: Si4401DDY-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter Drain-Source Voltage		Symbol	Limit	Unit	
		V _{DS}	- 40	V	
Gate-Source Voltage		V_{GS}	± 20	V	
	T _C = 25 °C		- 16.1		
Continuous Drain Current /T 150 °C)	T _C = 70 °C	1 .	- 12.9		
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	- I _D	- 10.2 ^{b, c}		
	T _A = 70 °C	1	- 8.2 ^{b, c}		
Pulsed Drain Current		I _{DM}	- 50	Α	
Continous Source-Drain Diode Current	T _C = 25 °C	- I _S	- 5.3		
Continous Source-Drain Diode Current	T _A = 25 °C		- 2.1 ^{b, c}		
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 28		
Single Pulse Avalanche Energy		E _{AS}	39	mJ	
	T _C = 25 °C		6.3		
Manianum Davida Disabahan	T _C = 70 °C	1 5	4	14/	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	W	
	T _A = 70 °C	1	1.6 ^{b, c}		
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	37	50	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	16	20			

Notes:

- a. Based on T_C = 25 °C. b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 85 °C/W.

Si4401DDY

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static					•		
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 40			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 36		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1D = - 230 μΑ		5		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_{D} = -250 \mu A$	- 1.2		- 2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Cuvvant	I _{DSS}	V _{DS} = - 40 V, V _{GS} = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current		$V_{DS} = -40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 5		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α	
Durin Course Co. Clata Basistana 3	D	V _{GS} = - 10 V, I _D = - 10.2 A		0.012	0.015		
Drain-Source On-State Resistance ^a	$R_{DS(on)}$	$V_{GS} = -4.5 \text{ V}, I_D = -8.4 \text{ A}$	0.018 0.0		0.022	Ω	
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 15 V, I _D = - 10.2 A		37		S	
Dynamic ^b					,	L	
Input Capacitance	C _{iss}			3007			
Output Capacitance	C _{oss}	V _{DS} = - 20 V, V _{GS} = 0 V, f = 1 MHz		335		pF	
Reverse Transfer Capacitance	C _{rss}			291			
Total Gate Charge	Q _g	V _{DS} = - 20 V, V _{GS} = - 10 V, I _D = - 10.2 A		64	95		
				33	50		
Gate-Source Charge	Q_{gs}	V _{DS} = - 20 V, V _{GS} = - 4.5 V, I _D = - 10.2 A		9.8		nC	
Gate-Drain Charge	Q_{gd}			15.7		1	
Gate Resistance	R_{g}	f = 1 MHz	0.4	2	4	Ω	
Turn-On Delay Time	t _{d(on)}			57	86		
Rise Time	t _r	$V_{DD} = -20 \text{ V}, \text{ R}_{L} = 2.4 \Omega$ $I_{D} \cong -8.2 \text{ A}, \text{ V}_{GEN} = -4.5 \text{ V}, \text{ R}_{g} = 1 \Omega$		50	75		
Turn-Off Delay Time	t _{d(off)}			40	60		
Fall Time	t _f			17	26		
Turn-On Delay Time	t _{d(on)}			13	20	ns	
Rise Time	t _r	V_{DD} = - 20 V, R_L = 2.4 Ω		11	20		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 8.2 A, V_{GEN} = - 10 V, R_g = 1 Ω		45	68		
Fall Time	t _f			9	18		
Drain-Source Body Diode Characteristic	s				,	L	
Continuous Source-Drain Diode Current	I _S	$T_C = 25 ^{\circ}C$			- 5.3	۸	
Pulse Diode Forward Current	I _{SM}				- 50	A	
Body Diode Voltage	V_{SD}	I _S = -8.2 A, V _{GS} = 0 V		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			36	54	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	L = 9.2 A dl/dt = 100 A/up T = 05 °C		41	62	nC	
Reverse Recovery Fall Time	t _a	$I_F = -8.2 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		20			
Reverse Recovery Rise Time	t _b	t _b		16		ns	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

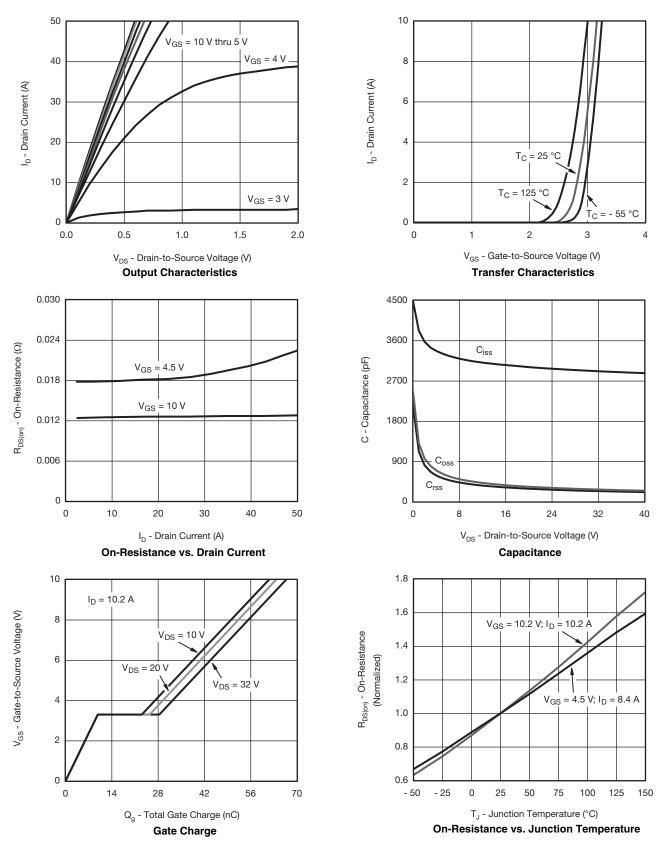
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.





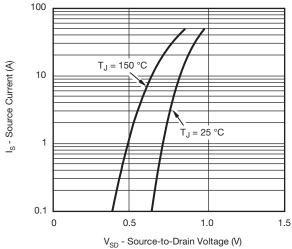
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



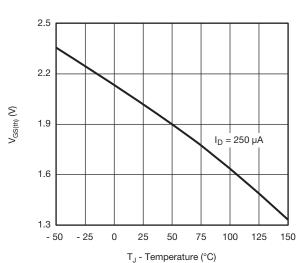
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



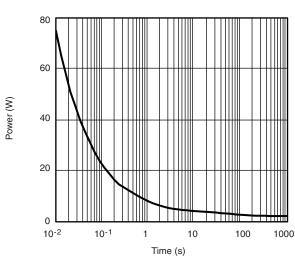
Source-Drain Diode Forward Voltage



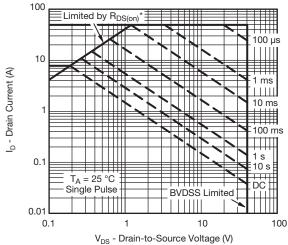
Threshold Voltage

 $I_D = 10.2 \text{ A}$ $I_D = 10.2$

On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power (Junction-to-Ambient)

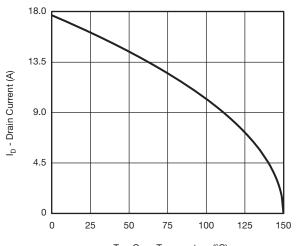


* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

Safe Operating Area, Junction-to-Ambient

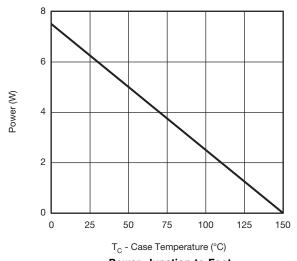


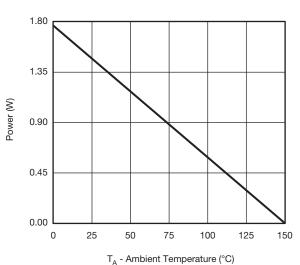
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



 T_C - Case Temperature (°C)

Current Derating*





Power, Junction-to-Ambient

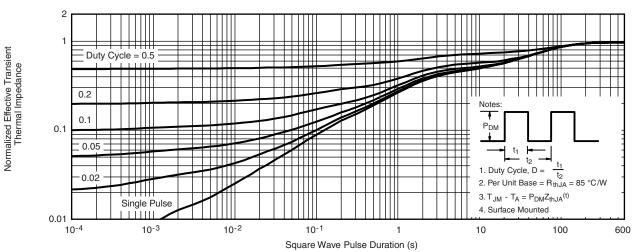
Power, Junction-to-Foot

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

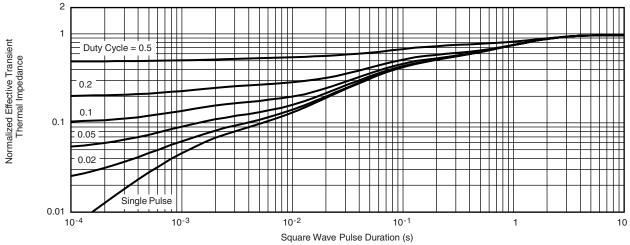
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	MILLIMETERS INCHES				
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
Е	3.80	4.00	0.150	0.157		
е	1.27	BSC	0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
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RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index

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